



Receipt

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

: Confirmation No. 7449

Kazuhiro OTSU et al.

: Docket No.2002-0208A

Serial No. 10/067,370

: Group Art Unit 2812

Filed February 7, 2002

SEPARATING MACHINE FOR THINNED
SEMICONDUCTOR SUBSTRATE AND
SEPARATION METHOD

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEE FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975.

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TC-2800 MAIL ROOM

REQUEST FOR CORRECTION OF INVENTOR'S NAME

Assistant Commissioner for Patents,
Washington, D.C.

Sir:

It is respectfully requested that the fourth inventor's name be changed from "Kazuhiro" OHYA to "Kazuyuki" OHYA.

The error arose in translating inventor Ohya's name from Japanese to English.

A request for corrected Filing Receipt accompanies.

Respectfully submitted,

Kazuhiro OTSU et al.

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May 2, 2002



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MAY 13 2002
TC 2800 MAIL ROOM

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :
Kazuhiro OTSU et al. : **Confirmation No. 7449**
Serial No. 10/067,370 : **Attn: Office of Initial Patent Examination's**
Filed February 7, 2002 : **Filing Receipt Correction**
: **Attorney Docket No. 2002-0208A**
SEPARATING MACHINE FOR THINNED :
SEMICONDUCTOR SUBSTRATE AND :
SEPARATION METHOD :
_____ : **THE COMMISSIONER IS AUTHORIZED**
: **TO CHARGE ANY DEFICIENCY IN THE**
: **FEE FOR THIS PAPER TO DEPOSIT**
: **ACCOUNT NO. 23-0975.**

REQUEST FOR CORRECTED FILING RECEIPT

Assistant Commissioner for Patents,
Washington, DC 20231

Sir:

A corrected filing receipt is requested in the above-referenced case. A copy of the original filing receipt is enclosed, with the changes noted thereon.

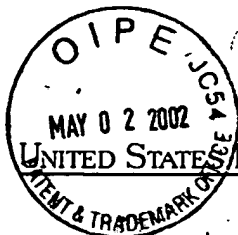
Expedited issuance of the corrected filing receipt is respectfully requested.

Respectfully submitted,

Kazuhiro OTSU et al.

By Matthew Jacob
Matthew Jacob
Registration No. 25,154
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May 2, 2002



COMMISSIONER FOR PATENTS
UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20531
www.uspto.gov

APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
10/067,370	02/07/2002	2812	740	2002-0208A	2	9	2

000513
WENDEROTH, LIND & PONACK, L.L.P.
2033 K STREET N. W.
SUITE 800
WASHINGTON, DC 20006-1021

CONFIRMATION NO. 7449
CORRECTED FILING RECEIPT



OC000000007936778

Date Mailed: 04/23/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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Kazuyuki

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APR 29 2002

Domestic Priority data as claimed by applicant

WENDEROTH, LIND & PONACK

Foreign Applications

JAPAN 30746/01 02/07/2001

If Required, Foreign Filing License Granted 04/05/2002

Projected Publication Date: 08/08/2002

Non-Publication Request: No

Early Publication Request: No

Title

Separating machine for thinned semiconductor substrate and separation method



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Bib Data Sheet

FILE COPY

CONFIRMATION NO. 7449

SERIAL NUMBER 10/067,370	FILING DATE 02/07/2002 RULE	CLASS 438	GROUP ART UNIT 2818	ATTORNEY DOCKET NO. 2002-0208A
APPLICANTS Kazuhiro Otsu, Tokyo, JAPAN; Hideki Kobayashi, Tokyo, JAPAN; Tatsuya Sasaki, Tokyo, JAPAN; Kazuyuki Ohya, Tokyo, JAPAN;				
** CONTINUING DATA ***** ** FOREIGN APPLICATIONS ***** JAPAN 30746/01 02/07/2001				
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 04/05/2002				
Foreign Priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after met Allowance Verified and Acknowledged _____ Examiner's Signature Initials		STATE OR COUNTRY JAPAN	SHEETS DRAWING 2	TOTAL CLAIMS 9
				INDEPENDENT CLAIMS 2
ADDRESS 000513				
TITLE Separating machine for thinned semiconductor substrate and separation method				
FILING FEE RECEIVED 740	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	